

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10813528			
<b>Filing Date:</b>	30-Mar-2004			
<b>Title of Invention:</b>	Method for producing structured substrate, structured substrate, method for producing semiconductor light emitting device, semiconductor light emitting device, method for producing semiconductor device, semiconductor device, method for producing device, and device			
<b>First Named Inventor/Applicant Name:</b>	Toshimasa Kobayashi			
<b>Filer:</b>	Tim Nitsch/Antonietta Anderson			
<b>Attorney Docket Number:</b>	09794353-0033			
Filed as Large Entity				
<b>Utility under 35 USC 111(a) Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 2 months with \$130 paid	1252	1	360	360

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Statutory disclaimer	1814	1	140	140
Total in USD (\$)				500